

MAXIMUM RATINGS

Rating	Symbol	MHQ4001A	MHQ4002A	Unit
Collector-Emitter Voltage	V_{CEO}	40	45	Vdc
Collector-Emitter Voltage	V_{CES}	60	70	Vdc
Collector-Base Voltage	V_{CBO}	60	70	Vdc
Emitter-Base Voltage	V_{EBO}	6.0		Vdc
Collector Current — Continuous	I_C	1.5		Adc
		Each Transistor	Four Transistors Equal Power	
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	750 4.3	2500 14.3	mW mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	1.2 6.86	4.0 22.8	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	– 55 to + 200		$^\circ\text{C}$

**MHQ4001A
MHQ4002A****CASE 632-02, STYLE 1
TO-116****QUAD
MEMORY DRIVER TRANSISTOR**

NPN SILICON

Refer to MD3725 for graphs.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage(1) ($I_C = 10 \text{ mA}\text{dc}, I_B = 0$)	$V_{(BR)CEO}$ MHQ4001A MHQ4002A	40 45	—	—	Vdc
Collector-Emitter Breakdown Voltage ($I_C = 10 \mu\text{A}\text{dc}, V_{BE} = 0$)	$V_{(BR)CES}$ MHQ4001A MHQ4002A	60 70	—	—	Vdc
Collector-Base Breakdown Voltage ($I_C = 10 \mu\text{A}\text{dc}, I_E = 0$)	$V_{(BR)CBO}$ MHQ4001A MHQ4002A	60 70	—	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 10 \mu\text{A}\text{dc}, I_C = 0$)	$V_{(BR)EBO}$	6.0	—	—	Vdc
Collector Cutoff Current ($V_{CB} = 30 \text{ Vdc}, I_E = 0$)	I_{CBO}	—	—	500	nAdc
ON CHARACTERISTICS(1)					
DC Current Gain ($I_C = 100 \text{ mA}\text{dc}, V_{CE} = 1.0 \text{ Vdc}$) ($I_C = 500 \text{ mA}\text{dc}, V_{CE} = 1.0 \text{ Vdc}$) ($I_C = 1.0 \text{ Adc}, V_{CE} = 5.0 \text{ Vdc}$)	h_{FE}	50 30 20	100 60 45	250 — —	—
Collector-Emitter Saturation Voltage ($I_C = 100 \text{ mA}\text{dc}, I_B = 10 \text{ mA}\text{dc}$) ($I_C = 500 \text{ mA}\text{dc}, I_B = 50 \text{ mA}\text{dc}$) ($I_C = 1.0 \text{ Adc}, I_B = 100 \text{ mA}\text{dc}$)	$V_{CE(\text{sat})}$	— — —	0.14 0.23 0.36	0.26 0.52 0.95	Vdc
Base-Emitter Saturation Voltage ($I_C = 100 \text{ mA}\text{dc}, I_B = 10 \text{ mA}\text{dc}$) ($I_C = 500 \text{ mA}\text{dc}, I_B = 50 \text{ mA}\text{dc}$) ($I_C = 1.0 \text{ Adc}, I_B = 100 \text{ mA}\text{dc}$)	$V_{BE(\text{sat})}$	— 0.8 —	0.75 0.88 1.0	0.86 1.1 1.7	Vdc

SMALL-SIGNAL CHARACTERISTICS

Current-Gain — Bandwidth Product(1) ($I_C = 50 \text{ mA}\text{dc}, V_{CE} = 10 \text{ Vdc}, f = 100 \text{ MHz}$)	f_T	200	275	—	MHz
Output Capacitance ($V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 100 \text{ kHz}$)	C_{obo}	—	5.0	10	pF
Input Capacitance ($V_{BE} = 0.5 \text{ Vdc}, I_C = 0, f = 100 \text{ kHz}$)	C_{ibo}	—	55	70	pF

SWITCHING CHARACTERISTICS

Turn-On Time ($V_{CC} = 30 \text{ Vdc}, I_C = 0.5 \text{ Adc}, V_{BE} = 3.8 \text{ Vdc}, I_{B1} = 50 \text{ mA}\text{dc}$)	t_{on}	—	30	40	ns
Turn-Off Time ($V_{CC} = 30 \text{ Vdc}, I_C = 0.5 \text{ Adc}, I_{B1} = I_{B2} = 50 \text{ mA}\text{dc}$)	t_{off}	—	60	75	ns

(1) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.